

BD241A/B/C BD242A/B/C

COMPLEMENTARY SILICON POWER TRANSISTORS

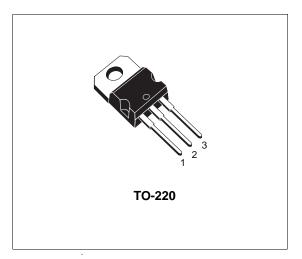
- STMicroelectronics PREFERRED SALESTYPES
- COMPLEMENTARY PNP NPN DEVICES

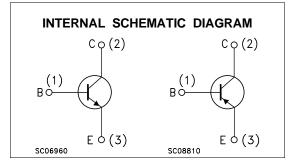
DESCRIPTION

The BD241A, BD241B and BD241C are silicon epitaxial-base NPN transistors mounted in Jedec TO-220 plastic package.

They are inteded for use in medium power linear and switching applications.

The complementary PNP types are BD242A, BD242B and BD242C respectively.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value				
		NPN	BD241A	BD241B	BD241C]	
		PNP	BD242A	BD242B	BD242C]	
V_{CER}	Collector-Base Voltage ($R_{BE} = 100 \Omega$)		70	90	115	V	
Vceo	Collector-Emitter Voltage (I _B = 0)		60	80	100	V	
V _{EBO}	Emitter-Base Voltage $(I_C = 0)$			5		V	
lc	Collector Current			3		Α	
Ісм	Collector Peak Current			5		Α	
IB	Base Current			1		Α	
P _{tot}	Total Dissipation at $T_c \le 25$ °C			40		W	
Ptot	Total Dissipation at $T_{amb} \le 25 \ ^{\circ}C$			W			
T _{stg}	Storage Temperature			-65 to 150		°C	

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THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Мах	3.13	°C/W
R _{thj} -amb	Thermal Resistance Junction-ambient	Max	62.5	°C/W

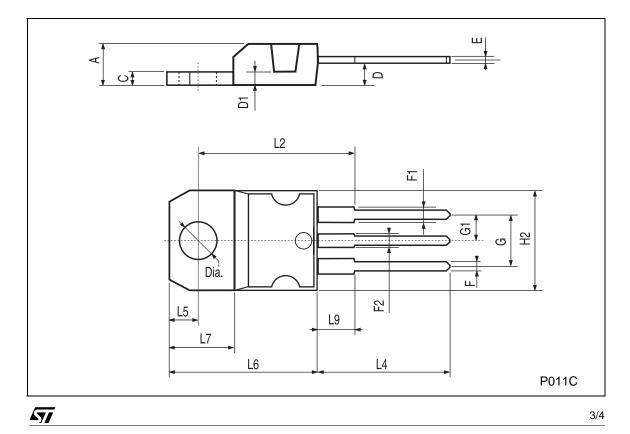
ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = rated V _{CEO}			0.2	mA
I _{CEO}	Collector Cut-off Current (I _B = 0)				0.3 0.3 0.3	mA mA mA
I _{EBO}	Emitter Cut-off Current $(I_C = 0)$	$V_{EB} = 5 V$			1	mA
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage	Ic = 30 mA for BD241A/BD242A for BD241B/BD242B for BD241C/BD242C	60 80 100			V V V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_{\rm C} = 3 \ {\sf A}$ $I_{\rm B} = 0.6 \ {\sf A}$			1.2	V
$V_{BE}*$	Base-Emitter Voltage	$I_C = 3 A$ $V_{CE} = 4 V$			1.8	V
h _{FE} *	DC Current Gain	$ I_C = 1 A \qquad V_{CE} = 4 V \\ I_C = 3 A \qquad V_{CE} = 4 V $	25 10			
h _{fe}	Small Signal Current Gain		3 20			

For PNP types voltage and current values are negative. For the characteristics curves see TIP31/TIP32 series.

DIM.		mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	4.40		4.60	0.173		0.181		
С	1.23		1.32	0.048		0.051		
D	2.40		2.72	0.094		0.107		
D1		1.27			0.050			
Е	0.49		0.70	0.019		0.027		
F	0.61		0.88	0.024		0.034		
F1	1.14		1.70	0.044		0.067		
F2	1.14		1.70	0.044		0.067		
G	4.95		5.15	0.194		0.203		
G1	2.4		2.7	0.094		0.106		
H2	10.0		10.40	0.393		0.409		
L2		16.4			0.645			
L4	13.0		14.0	0.511		0.551		
L5	2.65		2.95	0.104		0.116		
L6	15.25		15.75	0.600		0.620		
L7	6.2		6.6	0.244		0.260		
L9	3.5		3.93	0.137		0.154		
DIA.	3.75		3.85	0.147		0.151		





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